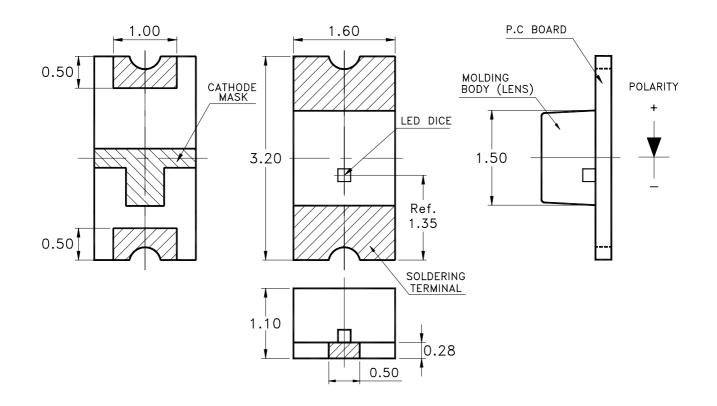
Property of Lite-On Only

#### Features

- \* Meet ROHS, Green Product.
- \* Reverse mount Chip LED.
- \* Package In 8mm Tape On 7" Diameter Reels.
- \* EIA STD package.
- \* I.C. compatible.
- \* Compatible With Automatic Placement Equipment.
- \* Compatible With Infrared And Vapor Phase Reflow Solder Process.

#### Package Dimensions



Part No.	Lens	Source
LTST-C230EKT	Water Clear	GaAsP on GaP Red

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.10 mm (.004") unless otherwise noted.

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#### BNS-OD-C131/A4

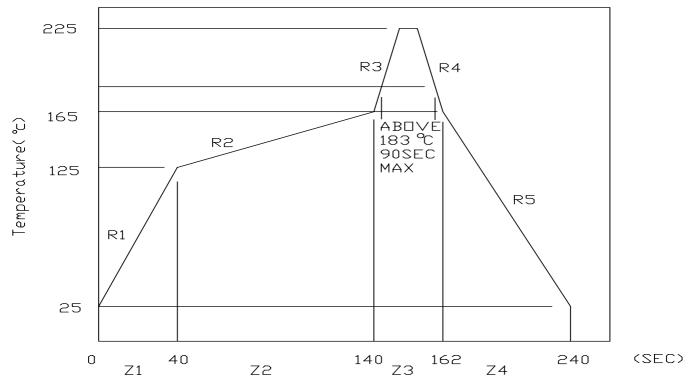
Property of Lite-On Only

Absolute Maximum Ratings At Ta	<b>==25°</b> ℃			
Parameter	LTST-C230EKT	Unit		
Power Dissipation	100	mW		
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	120 mA			
DC Forward Current	30 mA			
Derating Linear From 50°C	0.6 mA			
Reverse Voltage	5 V			
Operating Temperature Range	$-55^{\circ}$ C to $+85^{\circ}$ C			
Storage Temperature Range	$-55^{\circ}$ C to $+85^{\circ}$ C			
Wave Soldering Condition	260°C For 5 Seconds			
Infrared Soldering Condition	260°C For 5 Seconds			
Vapor Phase Soldering Condition	215°C For 3 Minutes			

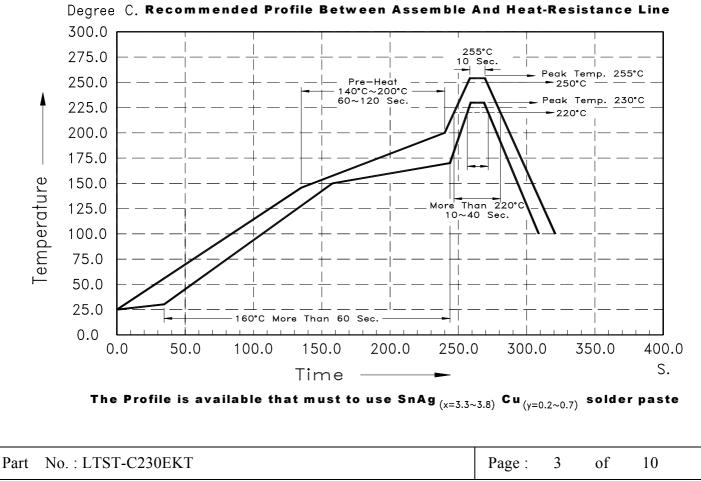
Property of Lite-On Only

## **Suggestion Profile:**

(1) Suggestion IR Reflow Profile For Normal Process



(2) Suggestion IR Reflow Profile For Pb Free Process



BNS-OD-C131/A4

## Property of Lite-On Only

Electrical Optical Characteristics At Ta=25°C									
Parameter	Symbol	Part No. LTST-	Min.	Тур.	Max.	Unit	Test Condition		
Luminous Intensity	IV	C230EKT	1.12	3.0		mcd	IF = 10mA Note 1		
Viewing Angle	2 0 1/2	C230EKT		130		deg	Note 2 (Fig.6)		
Peak Emission Wavelength	λΡ	C230EKT		630		nm	Measurement @Peak (Fig.1)		
Dominant Wavelength	λd	C230EKT		621		nm	Note 3		
Spectral Line Half-Width	Δλ	C230EKT		24		nm			
Forward Voltage	VF	C230EKT		2.0	2.6	V	IF = 20mA		
Reverse Current	IR	C230EKT			10	μA	VR = 5V		
Capacitance	С	C230EKT		20		PF	VF = 0 f = 1MHZ		

Notes: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2.  $\theta$  1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength,  $\lambda$  d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

# Property of Lite-On Only

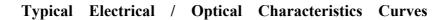
# **Bin Code List**

Luminous Intensity Unit :		: mcd @10mA
Bin Code	Min.	Max.
F	1.12	1.80
G	1.80	2.80
Н	2.80	4.50
J	4.50	7.10
К	7.10	11.2

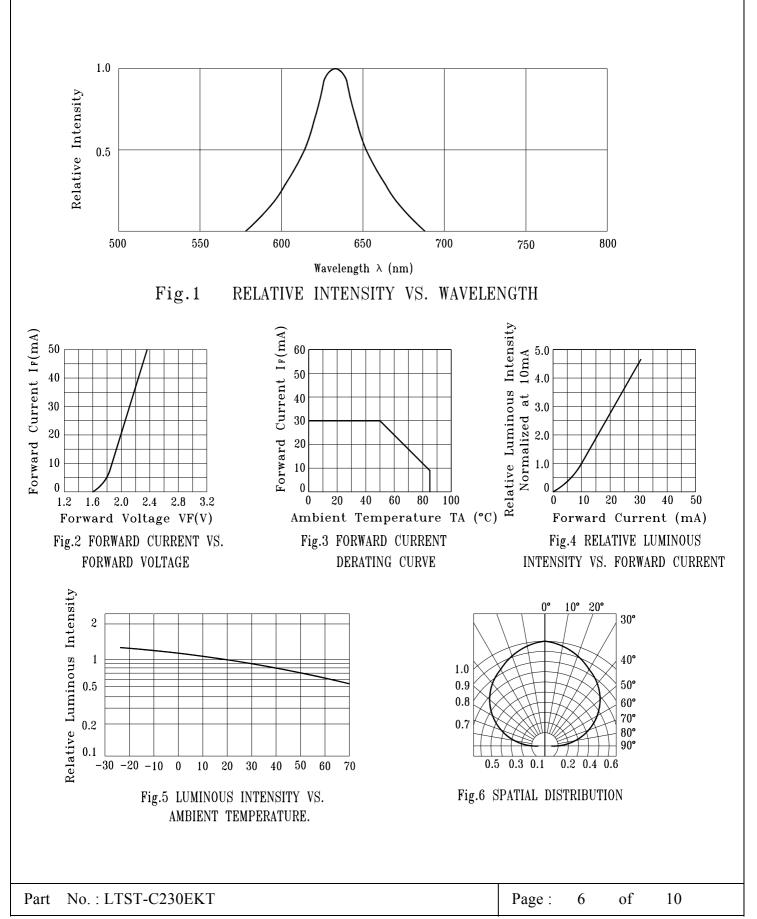
Tolerance on each Intensity bin is +/-15%

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Property of Lite-On Only



(25 °C Ambient Temperature Unless Otherwise Noted)



BNS-OD-C131/A4

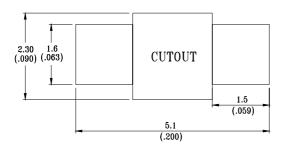
# Property of Lite-On Only

### Cleaning

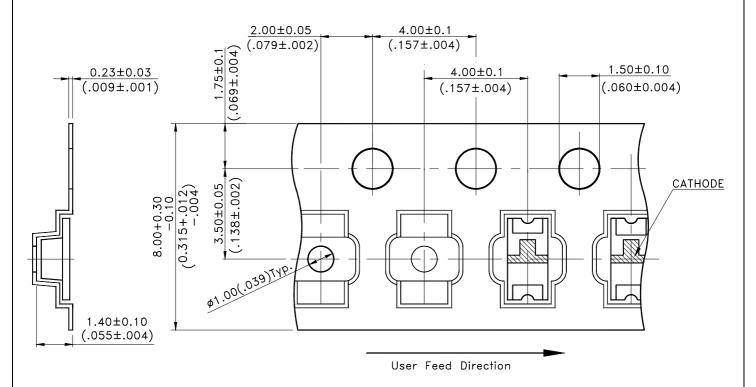
Do not use unspecified chemical liquid to clean LED they could harm the package.

If clean is necessary, immerse the LED in ethyl alcohol or in isopropyl alcohol at normal temperature for less one minute.

# **Suggest Soldering Pad Dimensions**



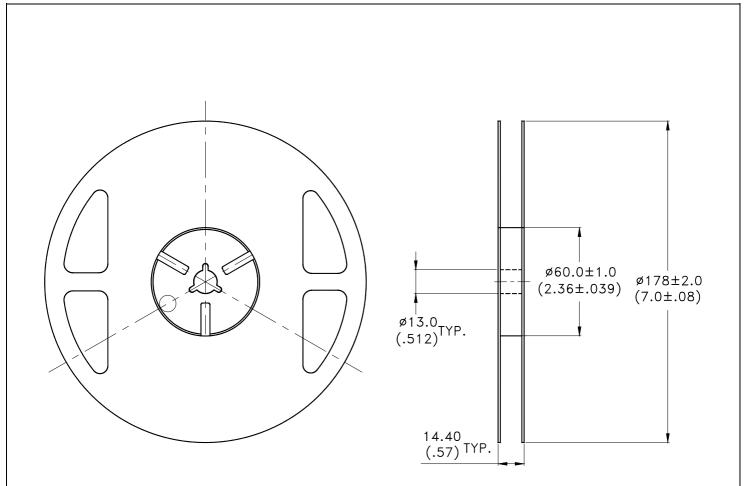
# Package Dimensions Of Tape And Reel



Notes:

1. All dimensions are in millimeters (inches).

Property of Lite-On Only



#### Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 7 inch reel-3000 pieces per reel.
- 3. Minimum packing quantity is 500 pcs for remainders.
- 4. The maximum number of consecutive missing lamps is two.
- 5. In accordance with ANSI/EIA 481-1-A-1994 specifications.

Property of Lite-On Only

# CAUTIONS

# 1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications).Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

### 2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are IR-reflowed within one week. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant, or in a desiccators with nitrogen ambient. LEDs stored out of their original packaging for more than a week should be baked at about 60 deg C for at least 24 hours before solder assembly.

### 3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

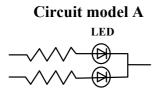
## 4. Soldering

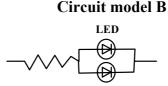
Recommended soldering conditions:

Reflow so	oldering	Wave So	ldering	Solderi	ng iron
Pre-heat Pre-heat time Peak temperature Soldering time	120 sec. Max. 240°C Max.		100°C Max. 60 sec. Max. 260°C Max. 10 sec. Max.	Soldering time	300°C Max. 3 sec. Max. (one time only)

# 5. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.





- (A) Recommended circuit.
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

### 6. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

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# Property of Lite-On Only

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or " no lightup " at low currents.

To verify for ESD damage, check for "lightup" and Vf of the suspect LEDs at low currents.

The Vf of "good " LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product.

### 7. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS C 7021:B-1
Endurance Test	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5°C,RH= 90~95% *Test Time= 240HRS±2HRS	MIL-STD-202F:103B JIS C 7021:B-11
	High Temperature Storage	Ta= 105±5°C *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 JIS C 7021:B-10
Low Temperatur Storage		Ta= -55±5°C *Test Time=1000HRS (-24HRS,+72H RS)	JIS C 7021:B-12
	Temperature Cycling	$105^{\circ}$ C ~ $25^{\circ}$ C ~ $-55^{\circ}$ C ~ $25^{\circ}$ C 30mins 5mins 30mins 5mins 10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS C 7021:A-4
	Thermal Shock	IR-Reflow In-Board, 2 Times $85 \pm 5^{\circ}$ C ~ $-40^{\circ}$ C $\pm 5^{\circ}$ C 10mins 10mins 10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1011
	Solder Resistance	T.sol= $260 \pm 5^{\circ}$ C Dwell Time= $10 \pm 1$ secs	MIL-STD-202F:210A MIL-STD-750D:2031 JIS C 7021:A-1
Environmental Test	IR-Reflow Normal Process	Ramp-up rate( $183^{\circ}$ C to Peak) +3°C/ second max Temp. maintain at $125(\pm 25)^{\circ}$ C 120 seconds max Temp. maintain above $183^{\circ}$ C 60-150 seconds Peak temperature range $235^{\circ}$ C +5/-0°C Time within 5°C of actual Peak Temperature (tp) 10-30 seconds Ramp-down rate +6°C/second max	MIL-STD-750D:2031.2 J-STD-020C
	IR-Reflow Pb Free Process	Ramp-up rate(217°C to Peak) +3°C/ second max Temp. maintain at 175( $\pm$ 25)°C 180 seconds max Temp. maintain above 217°C 60-150 seconds Peak temperature range 260°C+0/-5°C Time within 5°C of actual Peak Temperature (tp) 20-40 seconds Ramp-down rate +6°C/second max	MIL-STD-750D:2031.2 J-STD-020C
	Solderability	T.sol= $235 \pm 5^{\circ}$ C Immersion time 2±0.5 sec Immersion rate 25±2.5 mm/sec Coverage $\geq 95\%$ of the dipped surface	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 IEC 68 Part 2-20 JIS C 7021:A-2

#### 8. Others

The appearance and specifications of the product may be modified for improvement without prior notice.

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